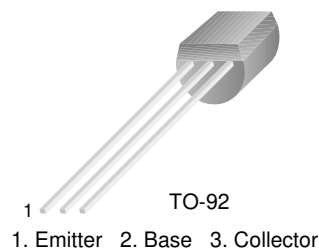


MPS6513

NPN General Purpose Amplifier

- This device is designed as a general purpose amplifier and switch.
- The useful dynamic range extends to 100mA as a switch and to 100MHz as an amplifier.
- Sourced from Proces 23.



Absolute Maximum Ratings $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	40	V
V_{CEO}	Collector-Emitter Voltage	30	V
V_{EBO}	Emitter-Base Voltage	4	V
I_C	Collector Current (DC)	200	mA
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 ~ 150	$^\circ\text{C}$

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1. These ratings are based on a maximum junction temperature of 150 degrees C.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Max.	Units
P_D	Total Device Dissipation	625	mW
	Derate above 25°C	5.0	mW/ $^\circ\text{C}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	$^\circ\text{C}/\text{W}$

*Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06".

Electrical Characteristics $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
BV_{CBO}	Collector-Base Voltage	$I_C = 10 \mu\text{A}$	40			V
BV_{CEO}	Collector-Emitter Voltage	$I_C = 0.5 \text{ mA}$	30			V
BV_{EBO}	Emitter-Base Voltage	$I_E = 10 \mu\text{A}$	4			V
I_{CBO}	Collector-Base Cut-off Current	$V_{CB} = 30 \text{ V}, T = 25^\circ\text{C}$ $T = 60^\circ\text{C}$			0.05 1.0	μA
h_{FE}	DC Current Gain	$V_{CE} = 10\text{V}, I_C = 2\text{mA}$ $V_{CE} = 10\text{V}, I_C = 100\text{mA}$	90 60		180	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 50 \text{ mA}, I_B = 5 \text{ mA}$			0.5	V
C_{ob}	Output Capacitance	$V_{CB} = 5\text{V}, f = 1.0 \text{ MHz}$			3.5	pF


NOTES:

1. These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.
3. These ratings are based on a maximum junction temperature of 150degrees C.



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